

Package Information

All HFBR-X5X5XFZ series transmitters and receivers are housed in a dual-in-line metal package that is high strength. The package is designed for auto-insertion and wave soldering so it is ideal for high volume production applications.

Handling and Design Information

When soldering, it is advisable to leave the protective cap on the unit to keep the optics clean. Good system performance requires clean port optics and cable ferrules to avoid obstructing the optical path. Clean compressed air often is sufficient to remove particles of dirt; methanol on a cotton swab also works well.

Recommended Chemicals for Cleaning/Degreasing HFBR-X5X5XFZ Products

Alcohols: methyl, isopropyl, isobutyl.

Aliphatics: hexane, heptane.

Other: soap solution, naphtha.

Do not use partially halogenated hydrocarbons such as 1,1,1 trichloroethane, ketones such as MEK, acetone, chloroform, ethyl acetate, methylene dichloride, phenol, methylene chloride or N-methylpyrrolidone. Also, Avago does not recommend the use of cleaners that use halogenated hydrocarbons because of their potential environmental harm.

CAUTION: The small junction size inherent in the design of these components increases the components' susceptibility to damage from electrostatic discharge (ESD). It is advised that normal static precautions be taken in handling and assembly of these components to prevent damage and/or degradation which may be induced by ESD.

Specified Link Performance

-40°C to +85°C unless otherwise noted.

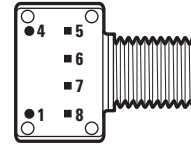
Parameter	Symbol	Min.	Max.	Unit	Condition	Reference
Link Distance with HFBR-1505AFZ/2505AFZ or HFBR-1515BFZ/2515BFZ	1	0.1 0.1	40 100	m m	POF HCS [®]	Notes 1, 2, 3, 4, 6 Notes 1, 2, 3, 5, 6
Link Distance with HFBR-1505CFZ/2505CFZ	1	0.1 0.1	50 300	m m	POF HCS [®]	Notes 1, 2, 3, 4, 7 Notes 1, 2, 3, 5, 7
Pulse Width Distortion with HFBR-1505AFZ/2505AFZ or HFBR-1515BFZ/2515BFZ	PWD	-30	+30	ns	25% to 75% duty cycle	Note 1
Pulse Width Distortion with HFBR-1505CFZ/2505CFZ	PWD	-125	+125	ns	arbitrary duty cycle	Note 1

Notes:

1. With recommended Tx and Rx circuits (60 mA nominal drive current).
2. POF HFBR-ExxyyyZ 0.23 dB/m worst case attenuation.
3. HCS Worst Case Attenuation is 10dB/km (0°C to 70°C) and 12dB/km (-40°C to 85°C).
4. Including a 3 dB optical safety margin accounting for link service lifetime.
5. Including a 2 dB optical safety margin accounting for link service lifetime.
6. Signaling rate DC to 10 MBd.
7. Signaling rate DC to 2 MBd.

HFBR-15X5XFZ Transmitters

The HFBR-15X5XFZ transmitter incorporates a 650 nm LED in a metal housing. The high light output power enables the use of both plastic optical fiber (POF) and Hard Clad Silica (HCS®). This transmitter can be operated up to 10 MBd using a simple driver circuit. The HFBR-1505XFZ is compatible with SMA connectors, while the HFBR-1515XFZ mates with ST® connectors.



BOTTOM VIEW,
HFBR-1505XFZ

SEE NOTE 10

PIN	FUNCTION
1	CONNECTED TO PIN 4
4	CONNECTED TO PIN 1
5	NC
6	NC
7	CATHODE
8	ANODE

Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit	Reference
Storage and Operating Temperature	T _{5,O}	-40	85	°C	
Peak Forward Input Current	I _{F,PK}		90	mA	Note 6
Average Forward Input Current	I _{F,AVG}		60	mA	
Reverse Input Voltage	V _R		3	V	
Lead Soldering Cycle	Temp	T _{SOL}	260	°C	Note 7, 12
	Time		10	s	

Electrical/Optical Characteristics

-40°C to +85°C unless otherwise noted.

Parameter	Symbol	Min.	Typ. ^[1]	Max.	Unit	Condition	Ref.
Optical Power Temperature Coefficient	$\Delta P_T / \Delta T$		-0.02		dB/°C		
Forward Voltage	V _F	1.8	2.1	2.65	V	I _{F,dc} = 60 mA	Fig. 1
Forward Voltage Temperature Coefficient	$\Delta V_F / \Delta T$		-1.8		mV/°C		Fig. 1
Breakdown Voltage	V _{BR}	3.0	13		V	I _{F,dc} = -10 μ A	
Peak Emission Wavelength	λ_{PK}	635	650	662	nm		Fig. 3
Full Width Half Max	FWHM		21	30	nm		Fig. 3
Diode Capacitance	C _O		60		pF	V _F = 0 V, f = 1 MHz	
Thermal Resistance	θ_{JC}		140		°C/W		Notes 4, 5
Rise Time (10% to 90%)	t _r		13		ns	10% to 90%, I _F = 60 mA	
Fall Time (90% to 10%)	t _f		10		ns		

EYE SAFETY: The HFBR-15x5xFZ is a Class 1 LED Product and eye safe when used within the data sheet limits and under normal operating conditions. This includes all reasonably foreseeable single fault conditions per IEC60825-1 and amendments.

Peak Output Power

-40°C to +85°C unless otherwise noted.

Model Number	Symbol	Min.	Max.	Unit	Condition	Reference
HFBR-1505AFZ SERCOS	P_T	-7.5	-3.5	dBm	POF, $I_{F,dc} = 60$ mA	Notes 2, 3, 11
		-18.0	-10		HCS [®] , $I_{F,dc} = 60$ mA	Figure 2
HFBR-1515BFZ PROFIBUS		-7.5	-3.5		POF, $I_{F,dc} = 60$ mA	Notes 2, 3, 11
		-18.0	-8.5		HCS [®] , $I_{F,dc} = 60$ mA	Figure 2
HFBR-1505CFZ INTERBUS-S		-6.2	0.0		POF, $I_{F,dc} = 60$ mA	Notes 3, 8, 9
		-16.9	-8.5		HCS [®] , $I_{F,dc} = 60$ mA	Figure 2

Notes:

1. Typical data at 25°C.
2. Optical power measured at the end of 0.5 meters of 1 mm diameter plastic optical fiber with a large area detector.
3. Minimum and maximum values for P_T over temperature are based on a fixed drive current. The recommended drive circuit has temperature compensation which reduces the variation in P_T over temperature, refer to Figures 4 and 6.
4. Thermal resistance is measured with the transmitter coupled to a connector assembly and fiber, and mounted on a printed circuit board.
5. To further reduce the thermal resistance, the cathode trace should be made as large as is consistent with good RF circuit design.
6. For $I_{F,pk} > 60$ mA, the duty factor must maintain $I_{F,avg} \leq 60$ mA and pulse width ≤ 1 μ s.
7. 1.6 mm below seating plane.
8. Minimum peak output power at 25°C is -5.3 dBm (POF) and -16.0 dBm (HCS[®]) for 1505CFZ series only.
9. Optical power measured at the end of 1 meter of 1 mm diameter plastic or 200 μ m hard clad silica optical fiber with a large area detector.
10. Pins 1 and 4 are for mounting and retaining purposes, but are electrically connected; pins 5 and 6 are electrically isolated. It is recommended that pins 1, 4, 5, and 6 all be connected to ground to reduce coupling of electrical noise.
11. Output power with 200 μ m hard clad silica optical fiber assumes a typical -10.5 dB difference compared to 1 mm plastic optical fiber.
12. Moisture sensitivity level (MSL) is 3.

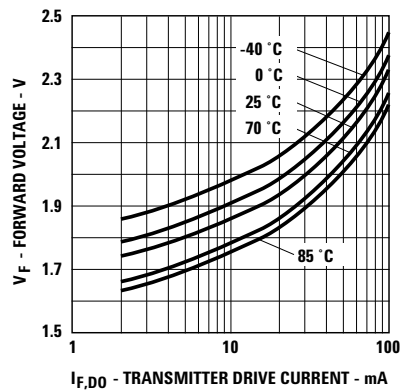


Figure 1. Typical forward voltage vs. drive current

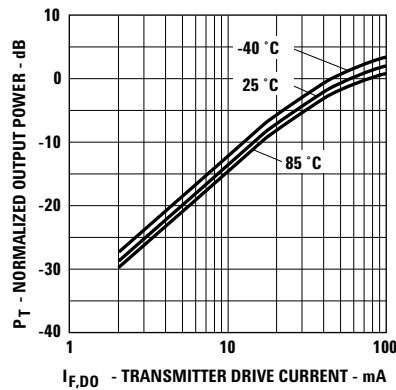


Figure 2. Typical normalized optical power vs. drive current

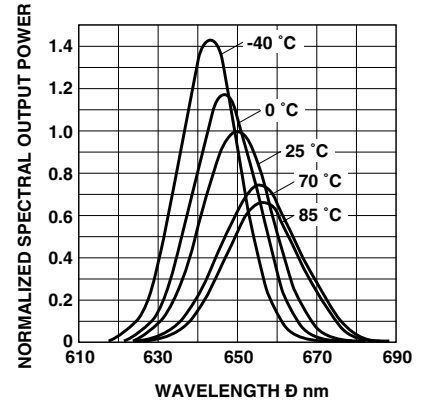


Figure 3. Typical normalized optical spectra

Recommended Drive Circuit for HFBR-x505AFZ/x515BFZ

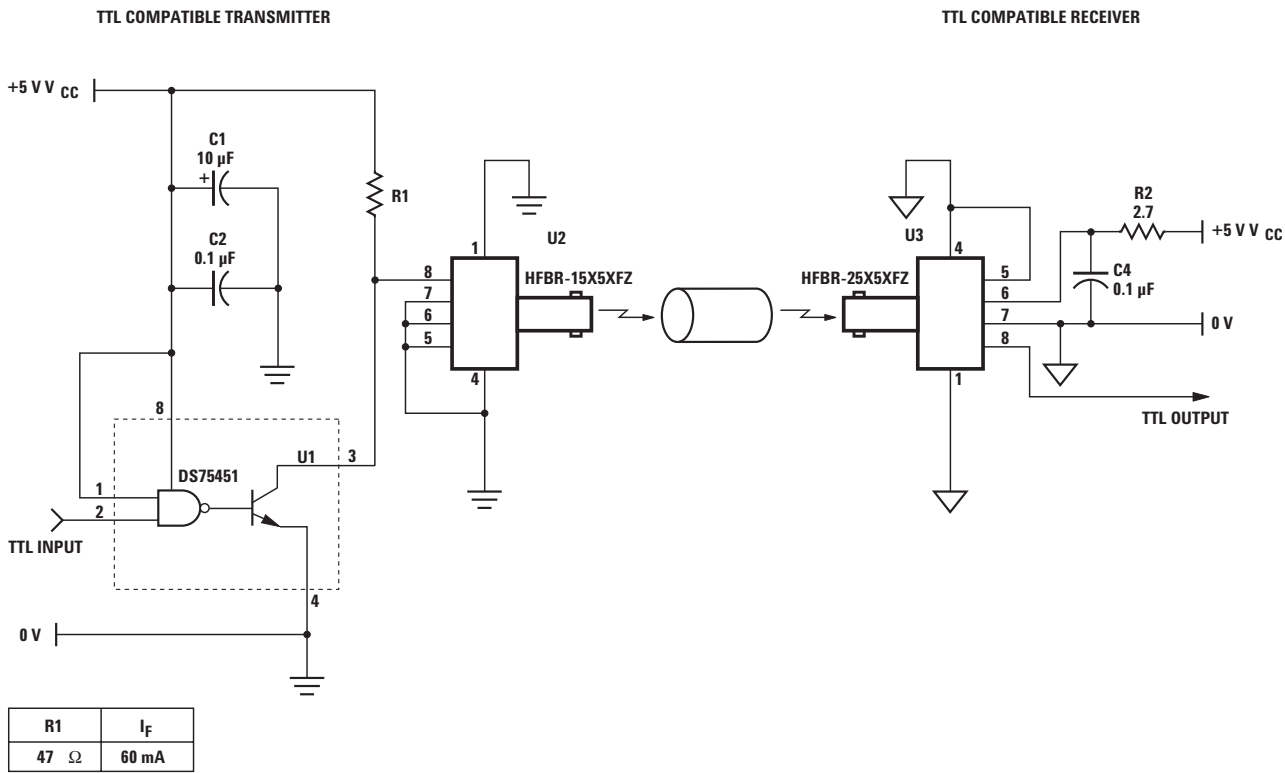
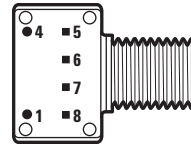


Figure 4. Recommended transmitter and receiver drive circuit ($I_{F, on} = 60 \text{ mA}$ nominal at $T_A = 25^\circ \text{C}$)

HFBR-25x5AFZ/BFZ Receivers

The HFBR-25x5AFZ/BFZ receiver consists of a silicon PIN photodiode and digitizing IC to produce a logic compatible output. The IC includes a unique circuit to correct the pulse width distortion of the first bit after a long idle period. This enables operation from DC to 10 MBd with low PWD for arbitrary data patterns. The receiver output is a "push-pull" stage compatible with TTL and CMOS logic. The HFBR-2505AFZ is compatible with SMA connectors, while the HFBR-2515BFZ mates with ST® connectors.



BOTTOM VIEW,
HFBR-2505AFZ/BFZ

SEE NOTE 4

PIN	FUNCTION
1	CONNECTED TO PIN 4
4	CONNECTED TO PIN 1
5	NO CONNECT
6	V _{CC}
7	GND
8	V _O

Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit	Reference
Storage and Operating Temperature	T _S	-40	85	°C	
Supply Voltage	V _{CC}	-0.5	+5.5	V	
Average Output Current	I _{O,AVG}	-16	+16	mA	
Output Power Dissipation	P _{OD}		80	mW	
Lead Soldering Cycle	Temp		260	°C	Note 2, 6
	Time		10	s	

Electrical/Optical Characteristics

-40°C to +85°C, 4.75 V < V_{CC} < 5.25 V, V_{P-P} Noise ≤ 100 mV unless otherwise noted

Parameter	Symbol	Min.	Typ. ^[1]	Max.	Unit	Condition	Ref.
Peak Input Power Level Logic HIGH	P _{RH}			-42 -44	dBm	1 mm POF 200 μm HCS®	Notes 3, 5
Peak Input Power Level Logic LOW	P _{RL}	-20 -22		-1 -3	dBm	1 mm POF, 200 μm HCS® PWD < 30 ns	Note 3 Figs. 7, 8, 9, 10
Supply Current	I _{CC}		19	45	mA	V _O = Open	
High Level Output Voltage	V _{OH}	4.2	4.7		V	I _O = -40 μA	
Low Level Output Voltage	V _{OL}		0.22	0.4	V	I _O = +1.6 mA	
Output Rise Time	t _r		12	30	ns	C _L = 10 pF	Note 3
Output Fall Time	t _f		10	30	ns	C _L = 10 pF	Note 3

Notes:

1. Typical data are at 25°C, V_{CC} = 5.0 V.
2. 1.6 mm below seating plane.
3. In recommended receiver circuit, with an optical signal from the recommended transmitter circuit.
4. Pins 1 and 4 are electrically connected to the metal housing and are also used for mounting and retaining purposes. It is required that pin 1 and 4 be connected to ground to maintain metal housing shield effectiveness.
5. BER ≤ 10E-9, includes a 10.8 dB margin below the receiver switching threshold level (signal to noise ratio = 12).
6. Moisture sensitivity level (MSL) is 3.

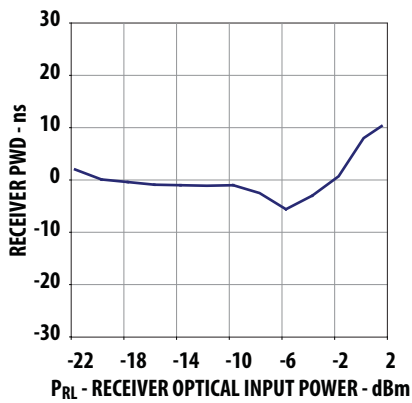


Figure 5. Typical POF receiver pulse width distortion vs. optical power at 10 MBd

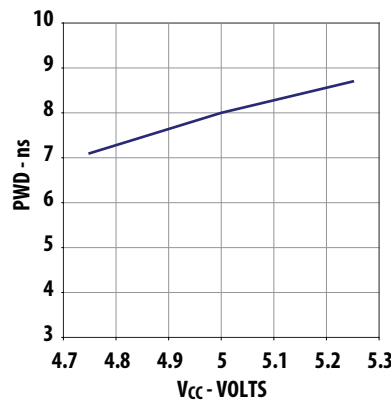


Figure 6. Typical POF receiver pulse width distortion vs. power supply voltage at high optical power, (0 dBm, 10 MBd)

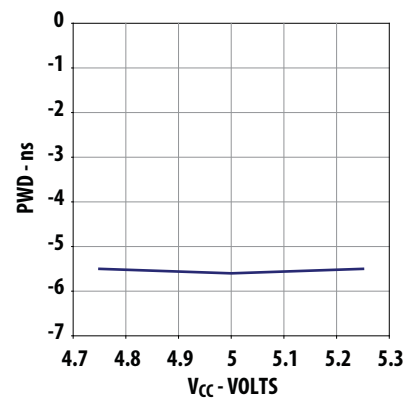
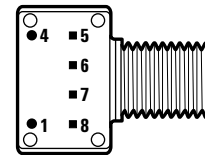


Figure 7. Typical POF receiver pulse width distortion vs. power supply voltage at mid optical power, (-6 dBm, 10 MBd)

HFBR-2505CFZ Receiver

The HFBR-2505CFZ receiver includes a monolithic DC coupled, digital IC receiver with open collector Schottky output transistor. An internal pullup resistor to V_{CC} is available at pin 5. The optical port is compatible with SMA connectors. The specified signal rate of HFBR-2505CFZ is 2 MBd.



BOTTOM VIEW,
HFBR 2505CFZ

SEE NOTE 3

PIN	FUNCTION
1	CONNECTED TO PIN 4
4	CONNECTED TO PIN 1
5	R_L
6	V_{CC}
7	GND
8	V_O

Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Units	Reference
Storage & Operating Temperatures	$T_{S,O}$	-40	+85	$^{\circ}\text{C}$	
Lead Soldering Cycle	Temp.		260	$^{\circ}\text{C}$	Note 1, 4
	Time		10	sec	
Supply Voltage	V_{CC}	-0.5	7	V	Note 2
Output Collector Current	I_{OAV}		25	mA	
Output Collector Power Dissipation	P_{OD}		40	mW	
Output Voltage	V_O	-0.5	18	V	
Pull-up Voltage	V_P	-5	V_{CC}	V	
Fan Out (TTL)	N		5		

Notes:

- 1.6 mm below seating plane.
- It is essential that a bypass capacitor 0.1 μF be connected from pin 6 to pin 7 of the receiver. Total lead length between both ends of the capacitor and the pins should not exceed 20 mm.
- Pins 1 and 4 are electrically connected to the metal housing and are also used for mounting and retaining purposes. It is required that pin 1 and 4 be connected to ground to maintain metal housing shield effectiveness.
- Moisture sensitivity level (MSL) is 3.

Receiver Electrical/Optical Characteristics

-40°C to +85°C, 4.75 V ≤ V_{CC} ≤ 5.25 V unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions	Ref.
Input Optical Power Level for Logic "0"	P _{R(L)}	-21.6		-2.0	dBm	V _{OL} = 0.5 V, I _{OL} = 8 mA 1 mm POF	Notes 1, 2
		-23.0				V _{OL} = 0.5 V, I _{OL} = 8 mA 200 μm HCS	
Input Optical Power Level for Logic "1"	P _{R(H)}			-43	dBm	V _{OL} = 5.25 V I _{OH} ≤ 250 μA	Note 1
High Level Output Current	I _{OH}		5	250	μA	V _O = 18 V, P _R = 0	Note 3
Low Level Output Current	V _{OL}		0.4	0.5	V	I _{OL} = 8 mA, P _R = P _{R(L)MIN}	Note 3
High Level Supply Current	I _{CCH}		3.5	6.5	mA	V _{CC} = 5.25 V, P _R = 0	Note 3
Low Level Supply Current	I _{CCL}		6.2	10.5	mA	V _{CC} = 5.25 V, P _R = -12.5 dBm	Note 3
Effective Diameter	D		1		mm		
Numerical Aperture	NA		0.5				
Internal Pull-up Resistor	R _L	680	1000	1700	Ω		

Notes:

- Optical flux, P (dBm) = 10 Log [P (μW)/1000 μW].
- Measured at the end of the fiber optic cable with large area detector.
- R_L is open.

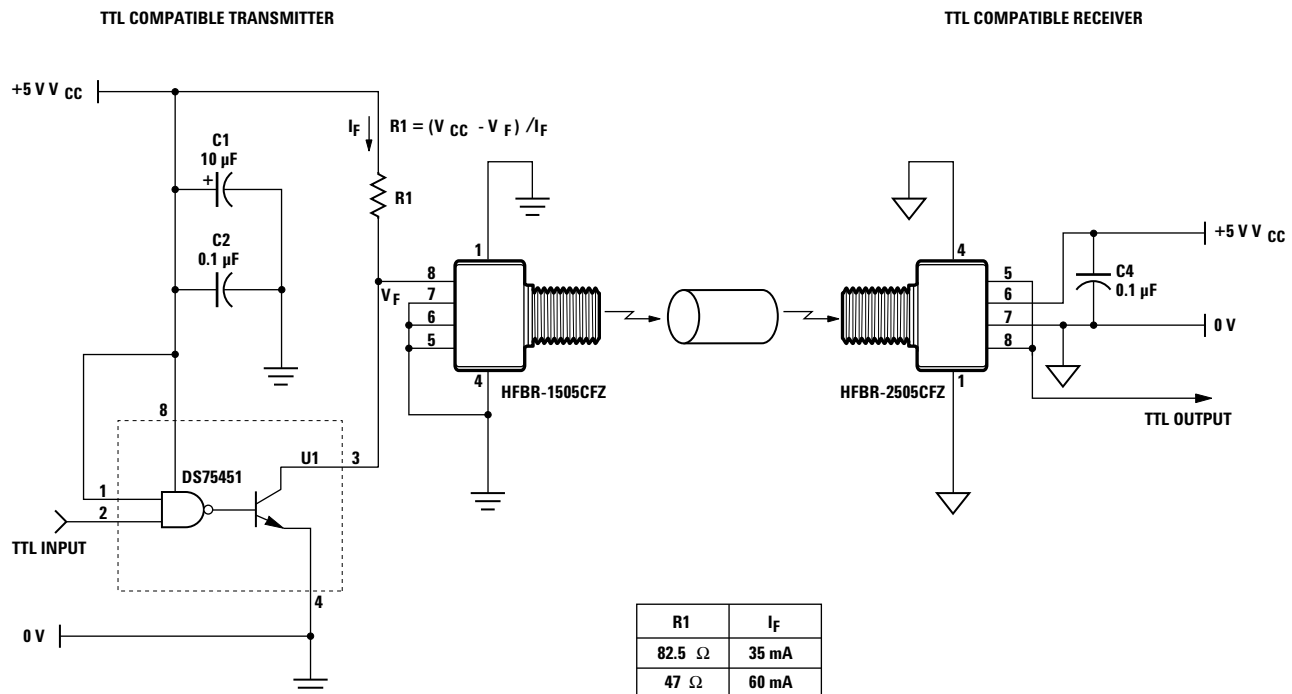
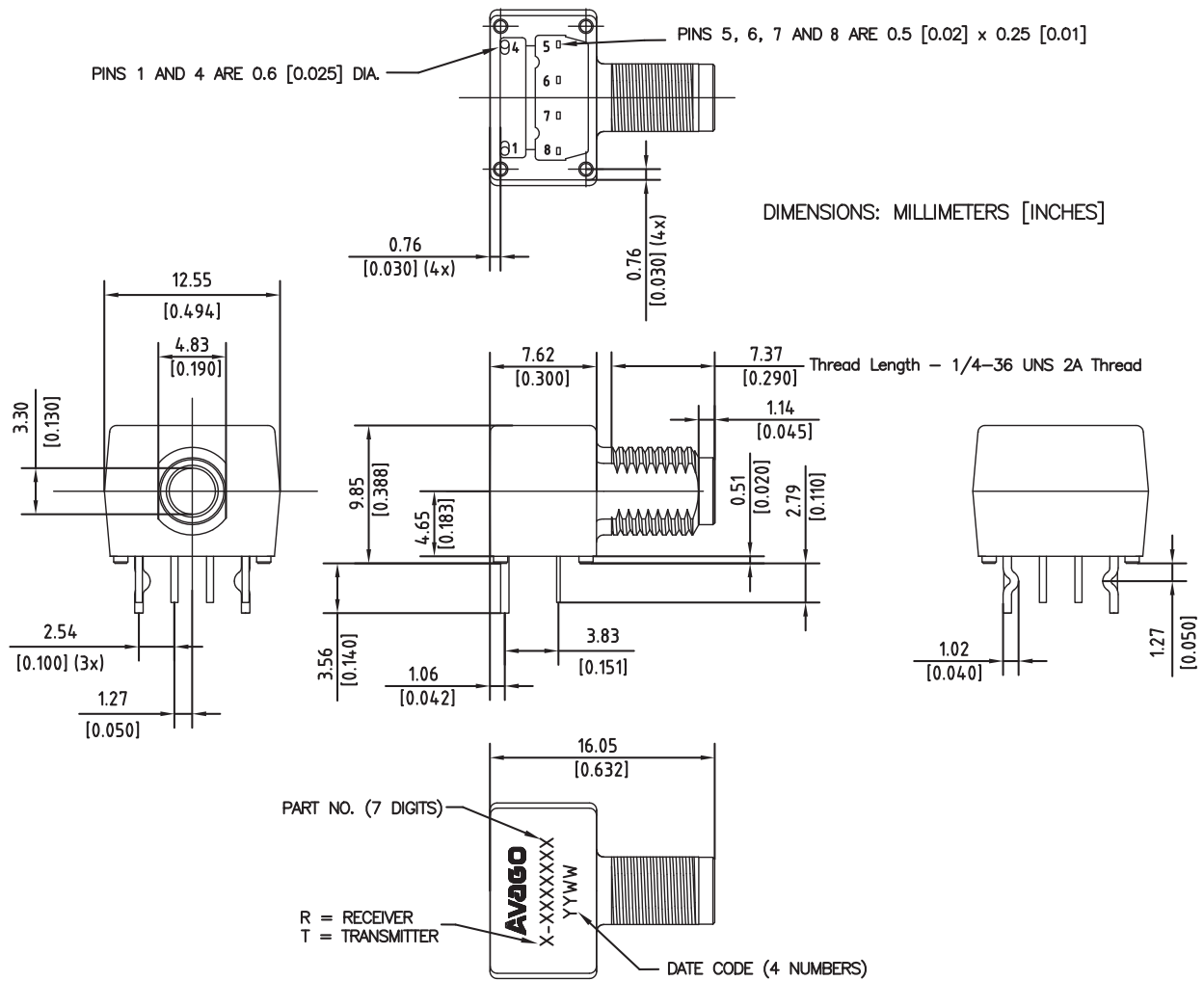


Figure 8. Typical interface circuit

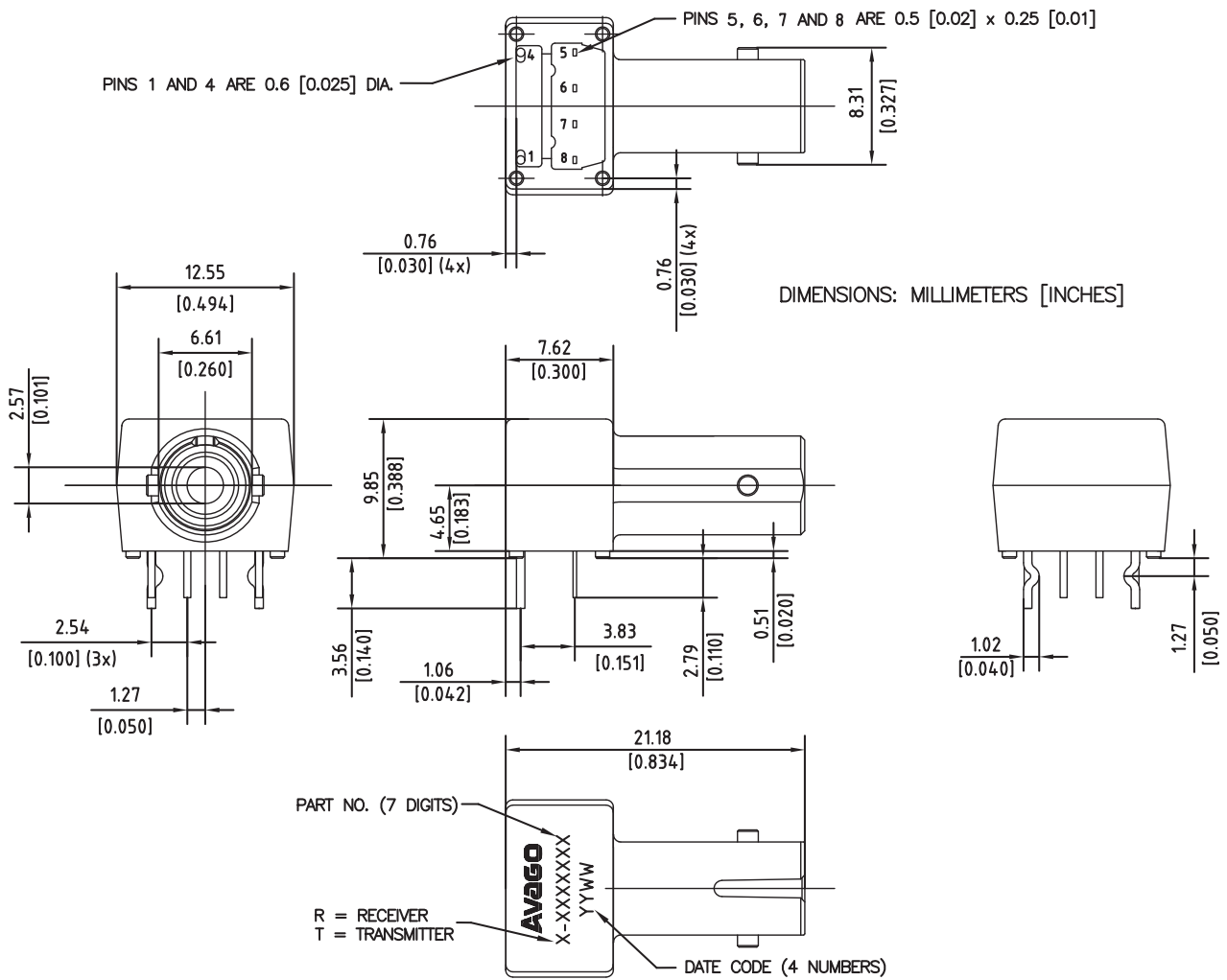
Mechanical Dimensions

HFBR-X505XFZ



Mechanical Dimensions (Cont.)

HFBR-X515XFZ



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